Vivian Zeru

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Education

Vanderbilt University

Aug 2023 - May 2027

Bachelor of Engineering in Electrical and Computer Engineering

- Coursework (Completed by Summer 2026): Microelectronic Systems, Microcontrollers, Embedded Systems, Electronics 1, Electromagnetics, Analog Circuits/Systems, Digital Systems (RISC-V), Circuits
- Cornelius Vanderbilt Scholar: Awarded scholarship to less than 1% of applicants for merit-based leadership and community achievement.

Vanderbilt University

Aug 2025 - May 2027

Master of Science in Electrical and Computer Engineering

- Coursework (Completed by Summer 2026): Electronics 2, Advanced Digital Electronics, VLSI Design
- Accelerated Graduate Program in Engineering: Accepted for reaching senior standing by end of sophomore year (86 credits required, 92 completed) & 3.5+ GPA to earn 2 degrees simultaneously in 4 years.

Technical Projects

4-Bit ALU (Arithmetic Logic Unit)

Jun 2025 - Jul 2025

- Designed in Verilog with 2-bit opcode for 4 options: Add, Subtract (using two's complement), Logical AND, Logical OR.
- Implemented 2 scalable design methodologies: behavorial (cases) & structural (gate-level hardware).
- Built 1 testbench (due to proper encapuslation of designs) for 100% design verification, with Synopsys VCS simulating a 6.74% decrease in CPU runtime for structural method (0.430 s versus 0.460 s).

Weather Station Aug 2022 - Present

- Developed a device using Arduino Uno (with C++ firmware) and a BME280 to detect temperature, humidity, pressure, and approximate altitude with LCD and RGB LED that visually displays temperature through 6 colors.
- Designed 2-layer PCB in Eagle, acheiving 24.73% size reduction using raw IC chips versus ESP32 & BME280 modules.

Professional Experience

Undergraduate Research Assistant - Electrical Engineering Team

Nashville, TN

Du Group Vanderbilt

Feb 2025 - Present

- Performed circuit analysis on pH sensor; contributed to physical design and schematic validation.
- Executed precise SMD soldering techniques on QFN/WLCSP microscopic components for high-reliability assembly (PCBA) on 1 wearable hardware sensor for ECG, EEG, and NIRS health monitoring.
- Debugged and validated low-power wearable PCB using multimeters and firmware flashing, enabling functional biosensor.

Information Services Management (ISM) Intern

Louisville, KY

UPS (United Parcel Service)

Jun 2024 - Aug 2024

- Developed/deployed scheduling feature for nationwide employee management system application that is in production today (over 1 year) for 2285 monthly users; selected to present to executive leadership for clarity and technical depth.
- \bullet Created real-time asset tracking app in 24-hour hackathon, enabling \$33M savings; selected top 9 of 53 teams.

Leadership Experience

Vice President (2025), Secretary (Fall 2024), Electronics Engineer (Stormwater Runoff Device, EPA Rainworks Project)

 $Nashville,\ TN$

Sept 2023 - Present

Engineers Without Borders USA - Vanderbilt University Chapter

- Designed 2-layer PCB (EasyEDA) with ESP8266 & sensors to decrease electronic space; debugged circuit and improved layout signal integrity.
- Decreased microcontroller power consumption by 99.9867% (150 mA to 20 μ A) using deep sleep mode every 15 seconds.
- Manage internal/external logistics and communicate to members via weekly emails & 8+ Instagram posts.

Lab Proctor and Founding Member

Nashville, TN

ECE Tech Crew

Feb 2021 - Present

- Trained 9 students in Keysight tools for debugging circuits in senior design & research (oscilloscopes, multimeters).
- Drove membership from 7 to 30+ members by creating merchandise, flyers, signs, and posters while streamlining communication on Slack and email between students and ECE faculty.
- Chosen to present to the ECE External Advisory Board (10+ faculty) at Vanderbilt on behalf of the organization.

Skills

Hardware Design/Simulation: Verilog, SPICE (LTSpice), Eagle, Altium, Fusion 360, Wolfram Mathematica, Intel Quartus/ModelSim Embedded Systems: C++ (Arduino), C (STM32), Python (Raspberry Pi), Assembly (RISC-V)

Lab & Tools: Oscilloscope, Multimeter, Waveform Generator, Power Supply, SMD Soldering (QFN/WLCSP), Soldering Iron, PCB Assembly